APPLICATION FOR SCHOLARSHIP RENEWAL

SOCIETY OF AMERICAN MILITARY ENGINEERS, OMAHA POST

(Please type or print information)

Scholarship:	□ SMP	🗆 Mary McKernan	Doug Plack
Legal Name of Applicant:	(Type or Print)		
		Attesting to the validity and accurac this application)	y of the information
Date			
Email:			
Mailing Address:			
Phone:			
Degree Field & University/College:			
Current Year in School:			
Grade Point Average (GPA):			
verification if necessary. Note	that the SMP and	cation, however SAME may request d Doug Plack Scholarships require a ewal require a 2.5 or greater GPA.)	a transcript for 3.0 or greater GPA for
Contact with SAME Mentor: (list interactions with mentor)			

Please submit this completed form to jshields@oppd.com or Joseph R. Shields, 12515 Harney Circle, Omaha, NE 68154 by February 1st.